



## General Description

- Latest AlphaGBT (αIGBT) technology
- 650V breakdown voltage
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low  $V_{CE(sat)}$  enables high efficiencies
- Low turn-off switching loss and softness
- Very good EMI behavior
- High short-circuit ruggedness

## Applications

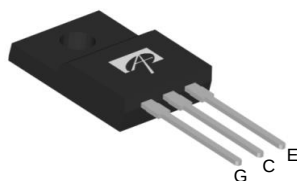
- Motor Drives
- Sewing Machines
- Home Appliances
- Fan, Pumps, Vacuum Cleaner
- Other Hard Switching Applications

## Product Summary

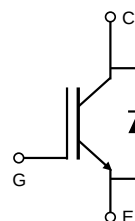
|                                          |      |
|------------------------------------------|------|
| $V_{CE}$                                 | 650V |
| $I_C$ ( $T_C=100^\circ\text{C}$ )        | 10A  |
| $V_{CE(sat)}$ ( $T_J=25^\circ\text{C}$ ) | 1.6V |



TO-220F



AOTF10B65M1



| Orderable Part Number                                                                                                   | Package Type    | Form        | Minimum Order Quantity |
|-------------------------------------------------------------------------------------------------------------------------|-----------------|-------------|------------------------|
| AOTF10B65M1                                                                                                             | TO220F          | Tube        | 1000                   |
| <b>Absolute Maximum Ratings</b> $T_A=25^\circ\text{C}$ unless otherwise noted                                           |                 |             |                        |
| Parameter                                                                                                               | Symbol          | AOTF10B65M1 | Units                  |
| Collector-Emitter Voltage                                                                                               | $V_{CE}$        | 650         | V                      |
| Gate-Emitter Voltage                                                                                                    | $V_{GE}$        | $\pm 30$    | V                      |
| Continuous Collector Current                                                                                            | $I_C$           | $20^{(2)}$  | A                      |
| $T_C=100^\circ\text{C}$                                                                                                 |                 | $10^{(2)}$  |                        |
| Pulsed Collector Current, Limited by $T_{Jmax}$                                                                         | $I_{CM}$        | 30          | A                      |
| Turn off SOA, $V_{CE} \leq 650\text{V}$ , Limited by $T_{Jmax}$                                                         | $I_{LM}$        | 30          | A                      |
| Continuous Diode Forward Current                                                                                        | $I_F$           | $20^{(2)}$  | A                      |
| $T_C=100^\circ\text{C}$                                                                                                 |                 | $10^{(2)}$  |                        |
| Diode Pulsed Current, Limited by $T_{Jmax}$                                                                             | $I_{FM}$        | 30          | A                      |
| Short circuit withstanding time $t_1$<br>$V_{GE}=15\text{V}$ , $V_{CC} \leq 400\text{V}$ , $T_J \leq 150^\circ\text{C}$ | $t_{SC}$        | 5           | $\mu\text{s}$          |
| Power Dissipation                                                                                                       | $P_D$           | 30          | W                      |
| $T_C=100^\circ\text{C}$                                                                                                 |                 | 12          |                        |
| Junction and Storage Temperature Range                                                                                  | $T_J, T_{STG}$  | -55 to 150  | $^\circ\text{C}$       |
| Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds                                            | $T_L$           | 300         | $^\circ\text{C}$       |
| <b>Thermal Characteristics</b>                                                                                          |                 |             |                        |
| Parameter                                                                                                               | Symbol          | AOTF10B65M1 | Units                  |
| Maximum Junction-to-Ambient                                                                                             | $R_{\theta JA}$ | 65          | $^\circ\text{C/W}$     |
| Maximum IGBT Junction-to-Case                                                                                           | $R_{\theta JC}$ | 4.2         | $^\circ\text{C/W}$     |
| Maximum Diode Junction-to-Case                                                                                          | $R_{\theta JC}$ | 7           | $^\circ\text{C/W}$     |

1) Allowed number of short circuits: <1000; time between short circuits: >1s.

2) TO220F  $I_C$  follows TO220/TO263.

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

| Symbol                                                      | Parameter                            | Conditions                                                                  | Min                | Typ  | Max       | Units    |         |
|-------------------------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------|--------------------|------|-----------|----------|---------|
| STATIC PARAMETERS                                           |                                      |                                                                             |                    |      |           |          |         |
| $BV_{CES}$                                                  | Collector-Emitter Breakdown Voltage  | $I_C=1mA, V_{GE}=0V, T_J=25^{\circ}C$                                       | 650                | -    | -         | V        |         |
| $V_{CE(sat)}$                                               | Collector-Emitter Saturation Voltage | $V_{GE}=15V, I_C=10A$                                                       | $T_J=25^{\circ}C$  | -    | 1.6       | 2        | V       |
|                                                             |                                      |                                                                             | $T_J=125^{\circ}C$ | -    | 1.86      | -        |         |
|                                                             |                                      |                                                                             | $T_J=150^{\circ}C$ | -    | 1.95      | -        |         |
| $V_F$                                                       | Diode Forward Voltage                | $V_{GE}=0V, I_C=10A$                                                        | $T_J=25^{\circ}C$  | -    | 1.9       | 2.4      | V       |
|                                                             |                                      |                                                                             | $T_J=125^{\circ}C$ | -    | 1.96      | -        |         |
|                                                             |                                      |                                                                             | $T_J=150^{\circ}C$ | -    | 1.95      | -        |         |
| $V_{GE(th)}$                                                | Gate-Emitter Threshold Voltage       | $V_{CE}=5V, I_C=1mA$                                                        | -                  | 5.1  | -         | V        |         |
| $I_{CES}$                                                   | Zero Gate Voltage Collector Current  | $V_{CE}=650V, V_{GE}=0V$                                                    | $T_J=25^{\circ}C$  | -    | -         | 10       | $\mu A$ |
|                                                             |                                      |                                                                             | $T_J=125^{\circ}C$ | -    | -         | 100      |         |
|                                                             |                                      |                                                                             | $T_J=150^{\circ}C$ | -    | -         | 500      |         |
| $I_{GES}$                                                   | Gate-Emitter leakage current         | $V_{CE}=0V, V_{GE}=\pm 30V$                                                 | -                  | -    | $\pm 100$ | nA       |         |
| $g_{FS}$                                                    | Forward Transconductance             | $V_{CE}=20V, I_C=10A$                                                       | -                  | 9    | -         | S        |         |
| DYNAMIC PARAMETERS                                          |                                      |                                                                             |                    |      |           |          |         |
| $C_{ies}$                                                   | Input Capacitance                    | $V_{GE}=0V, V_{CC}=25V, f=1MHz$                                             | -                  | 655  | -         | pF       |         |
| $C_{oes}$                                                   | Output Capacitance                   |                                                                             | -                  | 68   | -         | pF       |         |
| $C_{res}$                                                   | Reverse Transfer Capacitance         |                                                                             | -                  | 25   | -         | pF       |         |
| $Q_g$                                                       | Total Gate Charge                    | $V_{GE}=15V, V_{CC}=520V, I_C=10A$                                          | -                  | 24   | -         | nC       |         |
| $Q_{ge}$                                                    | Gate to Emitter Charge               |                                                                             | -                  | 5.5  | -         | nC       |         |
| $Q_{gc}$                                                    | Gate to Collector Charge             |                                                                             | -                  | 12   | -         | nC       |         |
| $I_{C(SC)}$                                                 | Short circuit collector current      | $V_{GE}=15V, V_{CC}=400V,$<br>$t_{sc}\leq 5\mu s, T_J\leq 150^{\circ}C$     | -                  | 70   | -         | A        |         |
| $R_g$                                                       | Gate resistance                      | $V_{GE}=0V, V_{CC}=0V, f=1MHz$                                              | -                  | 5.8  | -         | $\Omega$ |         |
| SWITCHING PARAMETERS, (Load Inductive, $T_J=25^{\circ}C$ )  |                                      |                                                                             |                    |      |           |          |         |
| $t_{D(on)}$                                                 | Turn-On DelayTime                    | $T_J=25^{\circ}C$<br>$V_{GE}=15V, V_{CC}=400V, I_C=10A,$<br>$R_G=30\Omega$  | -                  | 12   | -         | ns       |         |
| $t_r$                                                       | Turn-On Rise Time                    |                                                                             | -                  | 16   | -         | ns       |         |
| $t_{D(off)}$                                                | Turn-Off Delay Time                  |                                                                             | -                  | 91   | -         | ns       |         |
| $t_f$                                                       | Turn-Off Fall Time                   |                                                                             | -                  | 14   | -         | ns       |         |
| $E_{on}$                                                    | Turn-On Energy                       |                                                                             | -                  | 0.18 | -         | mJ       |         |
| $E_{off}$                                                   | Turn-Off Energy                      |                                                                             | -                  | 0.13 | -         | mJ       |         |
| $E_{total}$                                                 | Total Switching Energy               |                                                                             | -                  | 0.31 | -         | mJ       |         |
| $t_{rr}$                                                    | Diode Reverse Recovery Time          | $T_J=25^{\circ}C$<br>$I_F=10A, di/dt=200A/\mu s, V_{CC}=400V$               | -                  | 263  | -         | ns       |         |
| $Q_{rr}$                                                    | Diode Reverse Recovery Charge        |                                                                             | -                  | 0.4  | -         | $\mu C$  |         |
| $I_{rm}$                                                    | Diode Peak Reverse Recovery Current  |                                                                             | -                  | 3.8  | -         | A        |         |
| SWITCHING PARAMETERS, (Load Inductive, $T_J=150^{\circ}C$ ) |                                      |                                                                             |                    |      |           |          |         |
| $t_{D(on)}$                                                 | Turn-On DelayTime                    | $T_J=150^{\circ}C$<br>$V_{GE}=15V, V_{CC}=400V, I_C=10A,$<br>$R_G=30\Omega$ | -                  | 11   | -         | ns       |         |
| $t_r$                                                       | Turn-On Rise Time                    |                                                                             | -                  | 17   | -         | ns       |         |
| $t_{D(off)}$                                                | Turn-Off Delay Time                  |                                                                             | -                  | 108  | -         | ns       |         |
| $t_f$                                                       | Turn-Off Fall Time                   |                                                                             | -                  | 23   | -         | ns       |         |
| $E_{on}$                                                    | Turn-On Energy                       |                                                                             | -                  | 0.2  | -         | mJ       |         |
| $E_{off}$                                                   | Turn-Off Energy                      |                                                                             | -                  | 0.21 | -         | mJ       |         |
| $E_{total}$                                                 | Total Switching Energy               |                                                                             | -                  | 0.41 | -         | mJ       |         |
| $t_{rr}$                                                    | Diode Reverse Recovery Time          | $T_J=150^{\circ}C$<br>$I_F=10A, di/dt=200A/\mu s, V_{CC}=400V$              | -                  | 262  | -         | ns       |         |
| $Q_{rr}$                                                    | Diode Reverse Recovery Charge        |                                                                             | -                  | 0.6  | -         | $\mu C$  |         |
| $I_{rm}$                                                    | Diode Peak Reverse Recovery Current  |                                                                             | -                  | 4.5  | -         | A        |         |

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# TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

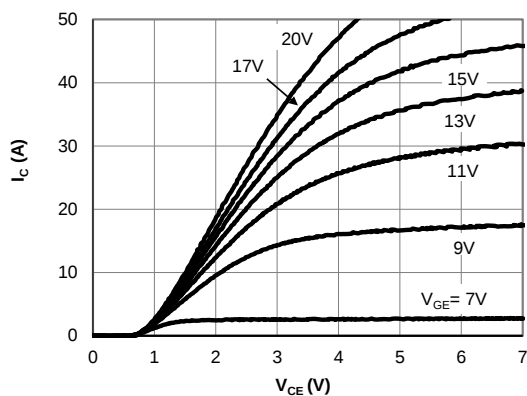


Figure 1: Output Characteristic  
( $T_j=25^\circ\text{C}$ )

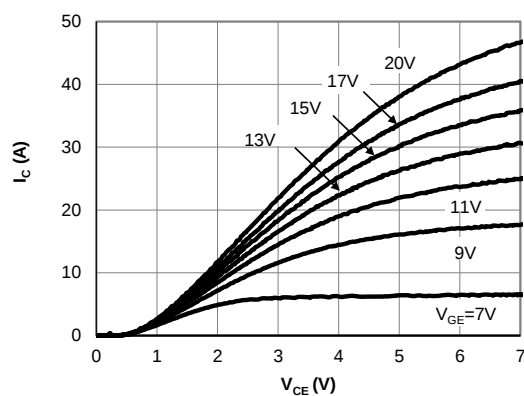


Figure 2: Output Characteristic  
( $T_j=150^\circ\text{C}$ )

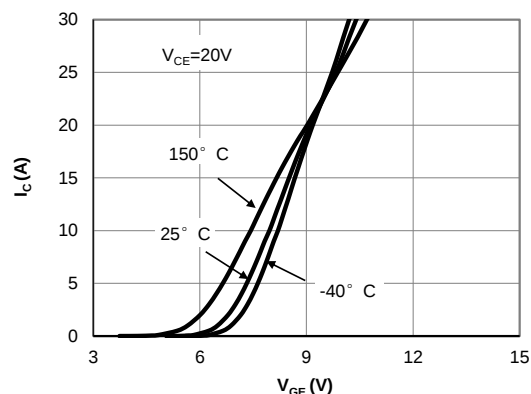


Figure 3: Transfer Characteristic

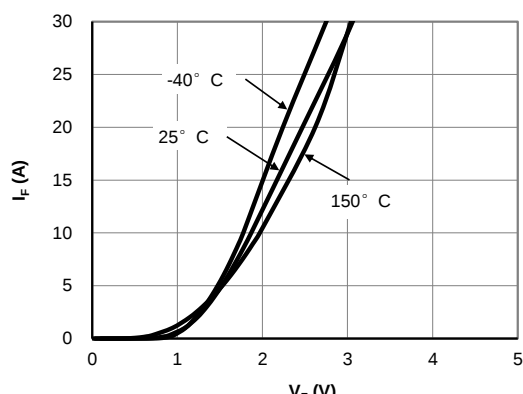


Figure 4: Diode Characteristic

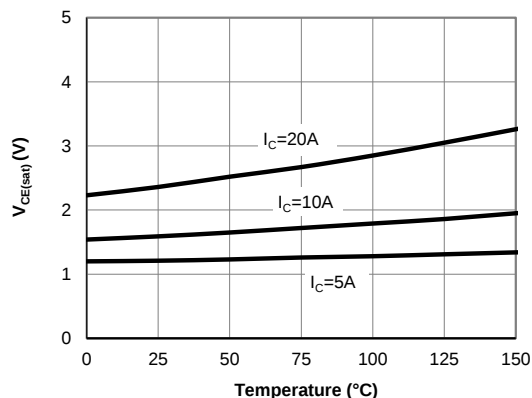


Figure 5: Collector-Emitter Saturation Voltage vs.  
Junction Temperature

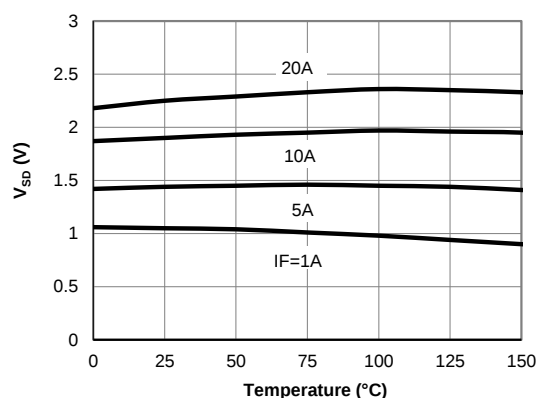


Figure 6: Diode Forward voltage vs. Junction  
Temperature

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

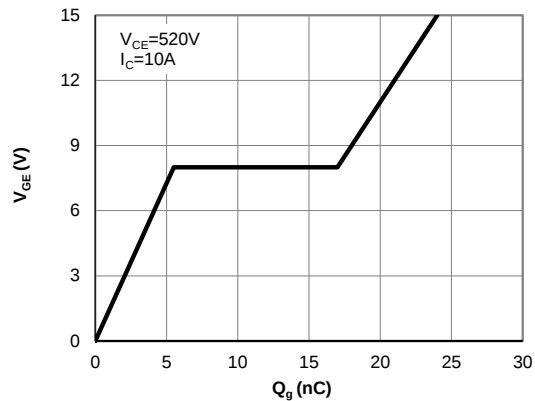


Figure 7: Gate-Charge Characteristics

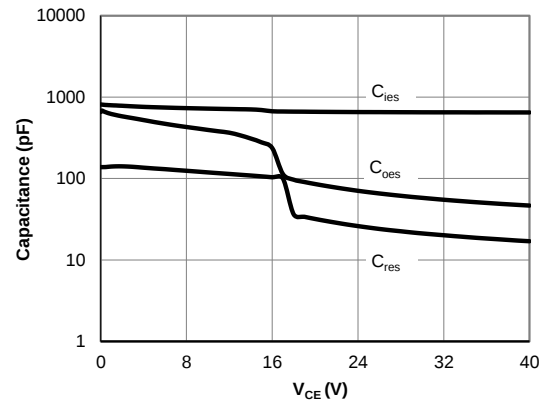


Figure 8: Capacitance Characteristic

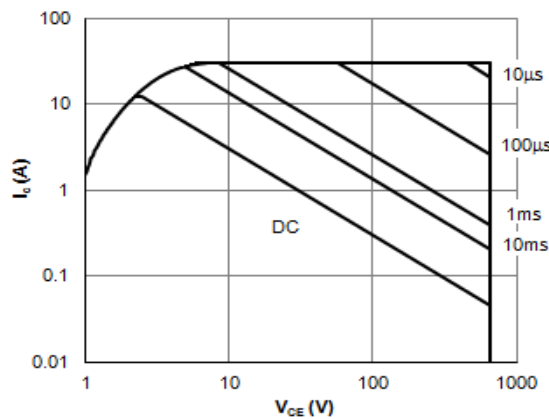


Figure 9: Forward Bias Safe Operating Area  
( $T_C=25^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ )

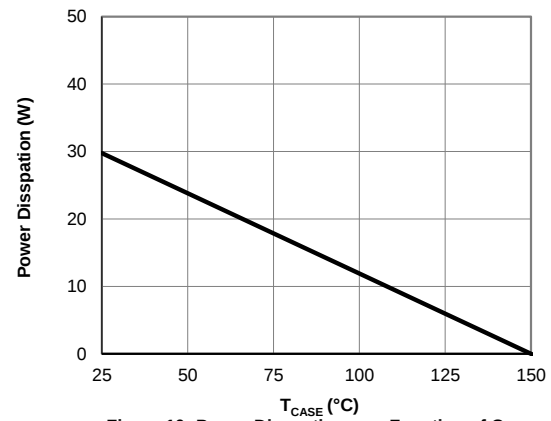


Figure 10: Power Dissipation as a Function of Case

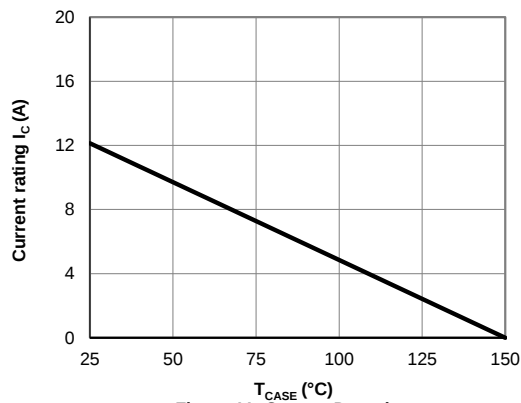


Figure 11: Current De-rating

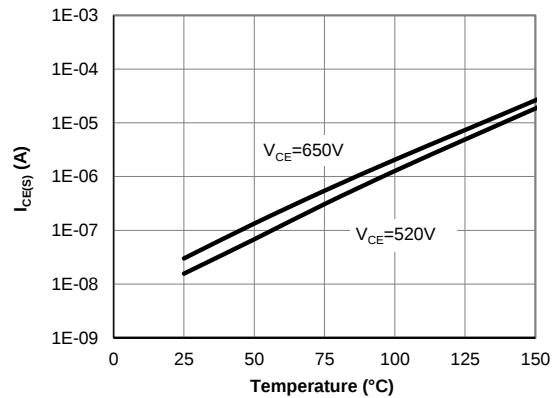


Figure 12: Diode Reverse Leakage Current vs. Junction Temperature

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

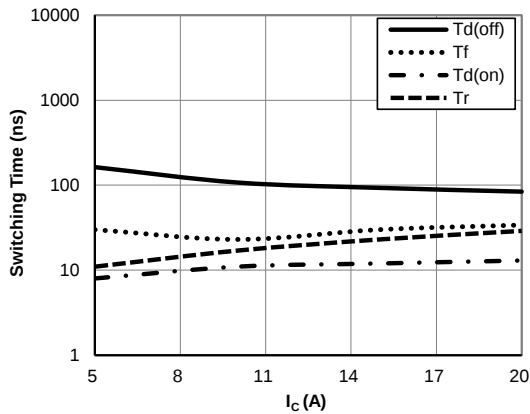


Figure 13: Switching Time vs.  $I_C$   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=30\Omega$ )

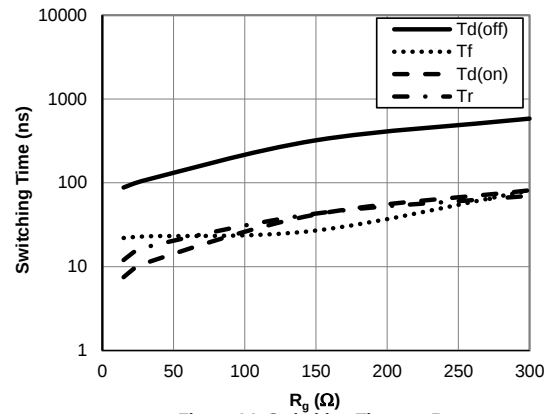


Figure 14: Switching Time vs.  $R_g$   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=10\text{A}$ )

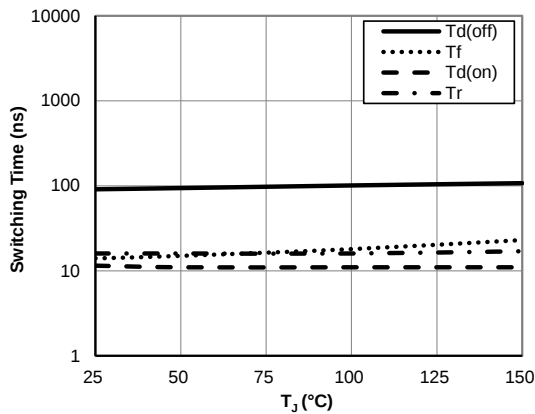


Figure 15: Switching Time vs.  $T_J$   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=10\text{A}$ ,  $R_g=30\Omega$ )

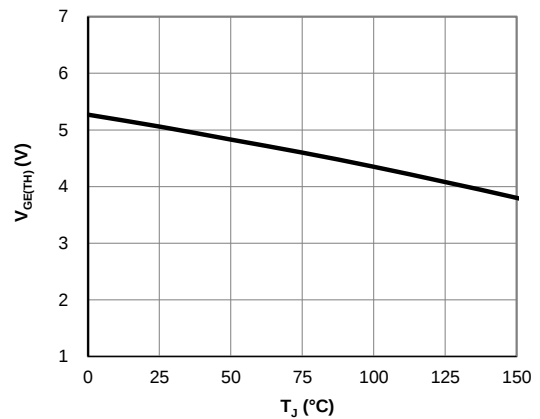
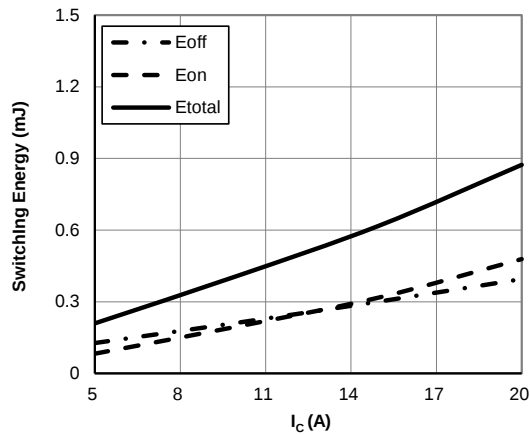
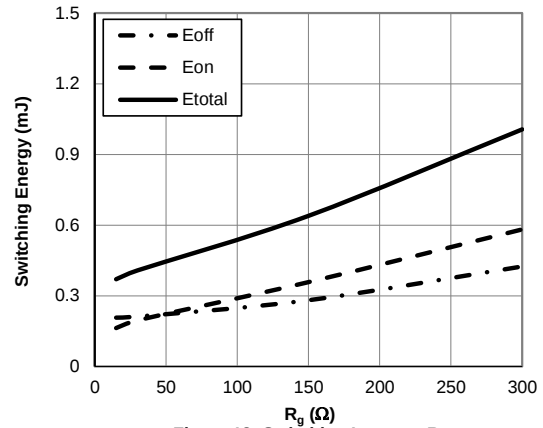


Figure 16:  $V_{GE(TH)}$  vs.  $T_J$

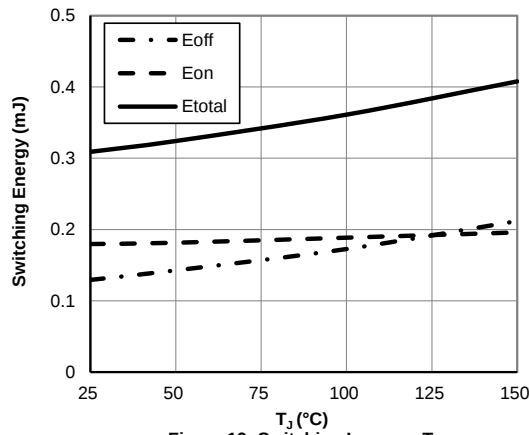
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



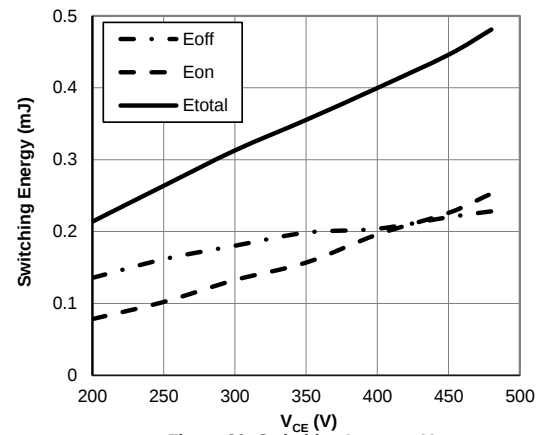
**Figure 17: Switching Loss vs.  $I_C$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $R_g=30\Omega$ )



**Figure 18: Switching Loss vs.  $R_g$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=10\text{A}$ )

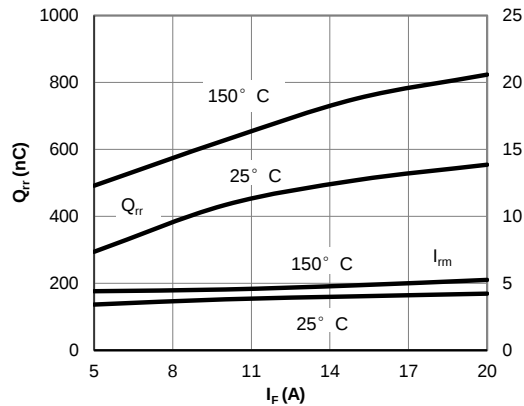


**Figure 19: Switching Loss vs.  $T_J$**   
( $V_{GE}=15\text{V}$ ,  $V_{CE}=400\text{V}$ ,  $I_C=10\text{A}$ ,  $R_g=30\Omega$ )

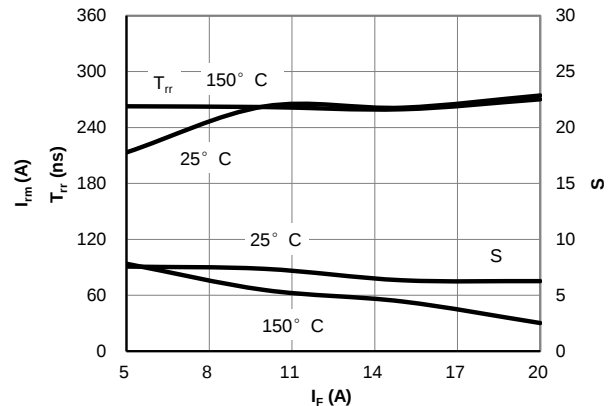


**Figure 20: Switching Loss vs.  $V_{CE}$**   
( $T_J=150^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $I_C=10\text{A}$ ,  $R_g=30\Omega$ )

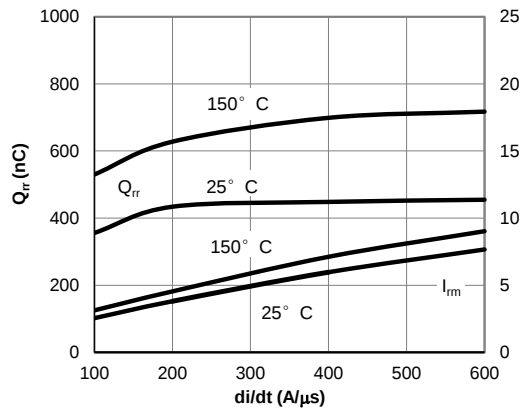
# TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



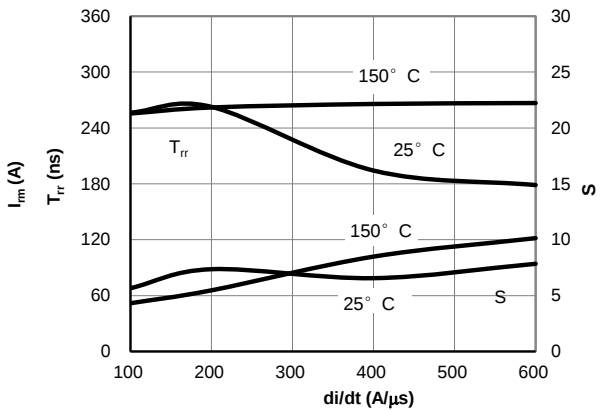
**Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )



**Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $di/dt=200A/\mu s$ )

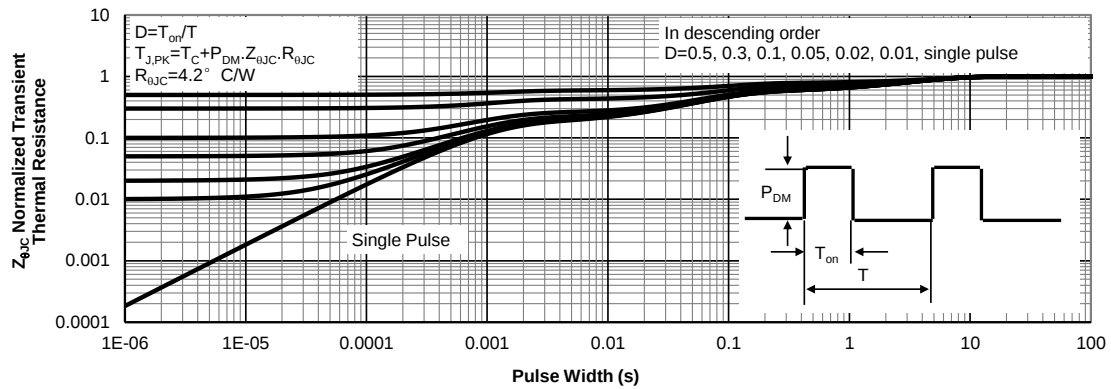


**Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=10A$ )

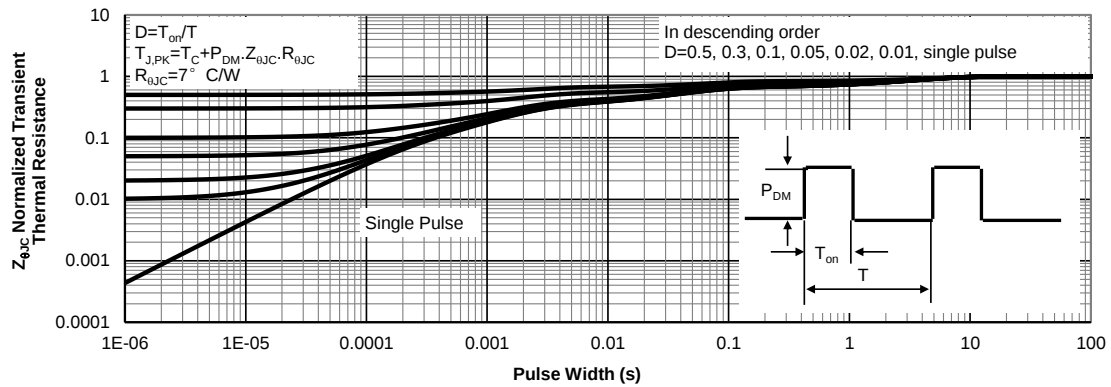


**Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt**  
( $V_{GE}=15V$ ,  $V_{CE}=400V$ ,  $I_F=10A$ )

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



**Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT**



**Figure 26: Normalized Maximum Transient Thermal Impedance for Diode**

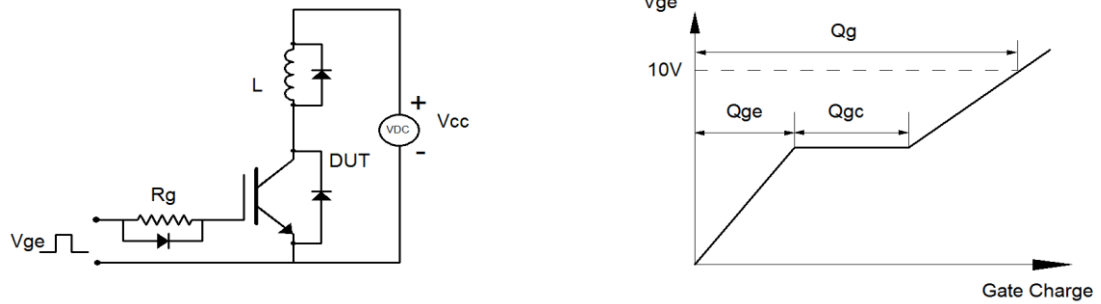


Figure A: Gate Charge Test Circuit & Waveforms

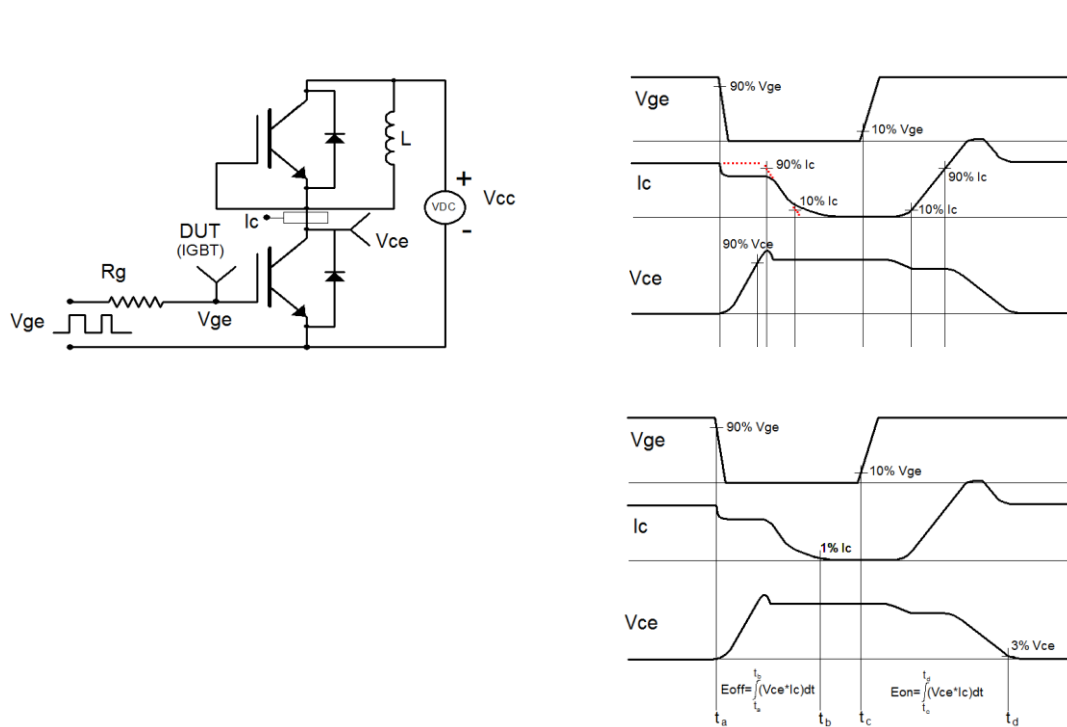


Figure B: Inductive Switching Test Circuit & Waveforms

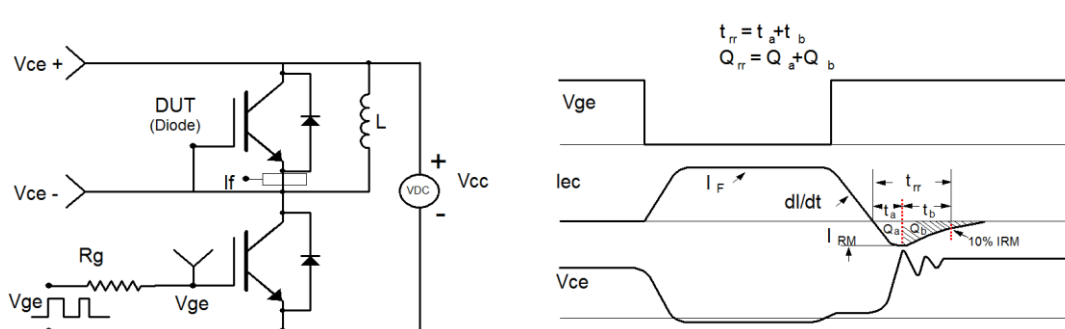


Figure C: Diode Recovery Test Circuit & Waveforms